## **Tyrone Camarero Specifications**

## Camarero DS300TR-14R

## Data Center Optimized, Short Depth

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/ v3 family
- Intel® C612 chipset
- Up to 1TB ECC 3DS LRDIMM, up to DDR4- 2400 MHz; 8x DIMM slots
- 1x PCI-E 3.0 x8 (FHHL)
- Intel® i210 Dual port Gigabit Ethernet
- IPMI 2.0 + KVM with Dedicated LAN
- 4x 3.5" Hot-swap SATA3 HDD Bays
- I/O ports: 2x SuperDOM, 1x VGA, 1x COM, 2x USB 3.0, 2x USB 2.0
- 400/600W Redundant Power Supplies Gold Level Certified







Processor/Cacl	he
Processor	Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/ v3 family
Chipset	
Chipset	Intel® C612 Express chipset
System Memor	у
Memory Capacit	y 8x 288-pin DDR4 DIMM slots, Up to 1TB ECC 3DS LRDIMM, 256GB ECC RDIMM
Expansion Slot	s
PCI-Express	1x PCI-E 3.0 x8 (FHHL)
Integrated On-I	Board
SATA	I-SATA 4 & I-SATA 5 support SATA DOM SATA3 (6Gbps); RAID 0, 1, 5, 10
LAN	2x RJ45 Gigabit Ethernet LAN ports 1x RJ45 Dedicated IPMI LAN port
Add-on Options	
Raid	Optional

Front Panel	
LEDs	Power status LED HDD activity LED , 2x Network activity LEDs Universal Information (UID) LED
Buttons	Power On/Off button System Reset button
Drive Bays	
HDD bays	4x 3.5" Hot-swap SATA HDD trays
Power Supply	
	400/600W Redundant Power Supplies Gold Level Certified
Cooling Syste	m
4×	4cm 17.5K RPM PWM fans
Form Factor	
	1U Rackmount
Dimension	Width-17.2" (437mm) , Height-1.7" (43mm), Depth-19.8" (503mm)
Em	ail: info@tyronesystems.com
	current product information, visit

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